

TOSHIBA Bi-CMOS INTEGRATED CIRCUIT SILICON MONOLITHIC

TB62003P, TB62003F, TB62003FW, TB62004P, TB62004F, TB62004FW, TB62006P, TB62006F, TB62006FW, TB62007P, TB62007F, TB62007FW, TB62008P, TB62008F, TB62008FW, TB62009P, TB62009F, TB62009FW

8CH DMOS TRANSISTOR ARRAY WITH GATE

TB62003P, TB62003F, TB62003FW
INVERTER & DMOS DRIVER

TB62004P, TB62004F, TB62004FW
THROUGH & DMOS DRIVER

TB62006P, TB62006F, TB62006FW
NAND & DMOS DRIVER

TB62007P, TB62007F, TB62007FW
AND & DMOS DRIVER

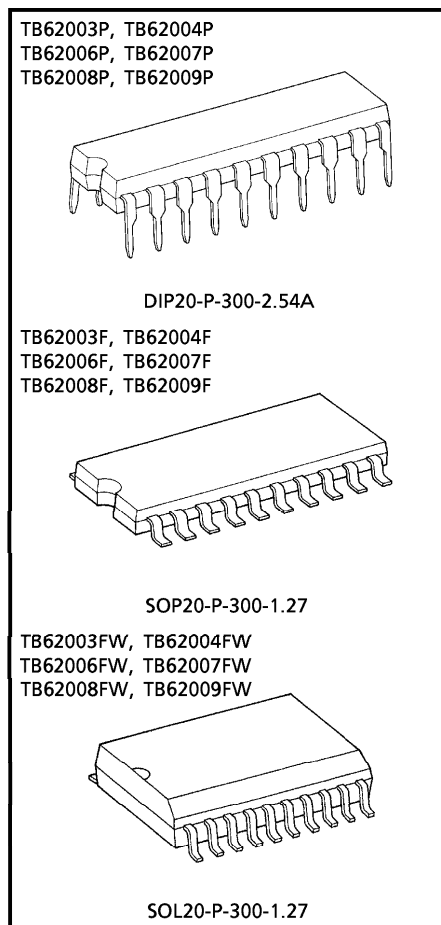
TB62008P, TB62008F, TB62008FW
NOR & DMOS DRIVER

TB62009P, TB62009F, TB62009FW
OR & DMOS DRIVER

The TB62003 Series are high-voltage, high-current arrays comprised of eight N-ch DMOS pairs.

FEATURES

- Package : Type-P DIP-20pin
 Type-F SOP-20pin (200mil)
 Type-FW SOL-20pin (300mil)
- Output rating : 35V (Min.) / 200mA (Max.)
- Low power



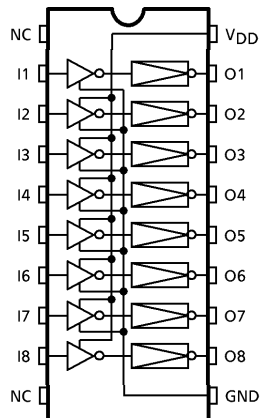
Weight
DIP20-P-300-2.54A : 2.25g (Typ.)
SOP20-P-300-1.27 : 0.25g (Typ.)
SOL20-P-300-1.27 : 0.48g (Typ.)

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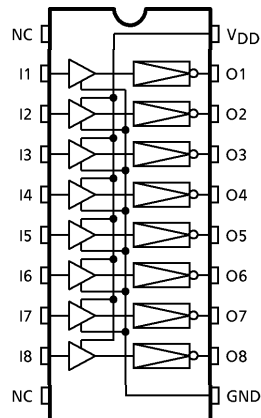
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PIN CONNECTION (TOP VIEW)

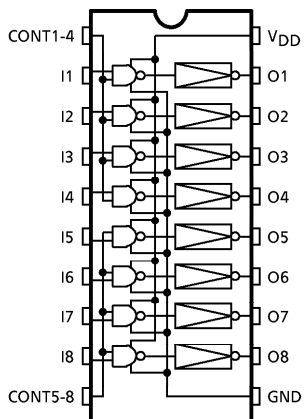
TB62003P / F / FW



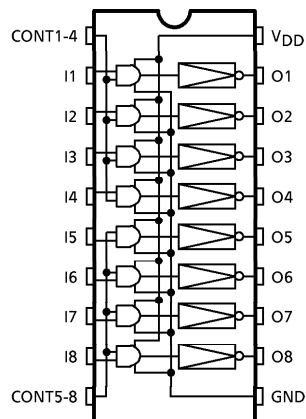
TB62004P / F / FW



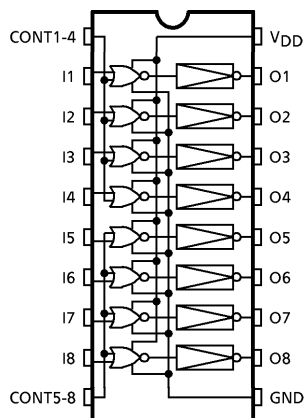
TB62006P / F / FW



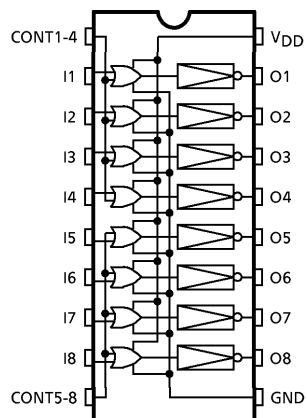
TB62007P / F / FW



TB62008P / F / FW



TB62009P / F / FW



TRUTH TABLE
TB62006P/F/FW

INPUT				OUTPUT	
I1~4	I5~8	CONT1~4	CONT5~8	O3~4	O5~8
H	X	H	X	OFF	NOT FIX
H	X	L	X	ON	NOT FIX
L	X	H	X	ON	NOT FIX
L	X	L	X	ON	NOT FIX
X	H	X	H	NOT FIX	OFF
X	H	X	L	NOT FIX	ON
X	L	X	H	NOT FIX	ON
X	L	X	L	NOT FIX	ON

X : Don't Care

TB62007P/F/FW

INPUT				OUTPUT	
I1~4	I5~8	CONT1~4	CONT5~8	O3~4	O5~8
H	X	H	X	ON	NOT FIX
H	X	L	X	OFF	NOT FIX
L	X	H	X	OFF	NOT FIX
L	X	L	X	OFF	NOT FIX
X	H	X	H	NOT FIX	ON
X	H	X	L	NOT FIX	OFF
X	L	X	H	NOT FIX	OFF
X	L	X	L	NOT FIX	OFF

X : Don't Care

TB62008P/F/FW

INPUT				OUTPUT	
I1~4	I5~8	CONT1~4	CONT5~8	O3~4	O5~8
H	X	H	X	OFF	NOT FIX
H	X	L	X	OFF	NOT FIX
L	X	H	X	OFF	NOT FIX
L	X	L	X	ON	NOT FIX
X	H	X	H	NOT FIX	OFF
X	H	X	L	NOT FIX	OFF
X	L	X	H	NOT FIX	OFF
X	L	X	L	NOT FIX	ON

X : Don't Care

TB62009P/F/FW

INPUT				OUTPUT	
I1~4	I5~8	CONT1~4	CONT5~8	O3~4	O5~8
H	X	H	X	ON	NOT FIX
H	X	L	X	ON	NOT FIX
L	X	H	X	ON	NOT FIX
L	X	L	X	OFF	NOT FIX
X	H	X	H	NOT FIX	ON
X	H	X	L	NOT FIX	ON
X	L	X	H	NOT FIX	ON
X	L	X	L	NOT FIX	OFF

X : Don't Care

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	V _{DD}	7	V
DC Output Voltage	V _{DS}	- 0.5~35	V
DC Output Current	I _{DS}	200	mA / ch
DC Input Voltage	V _{IN}	- 0.4 + V _{DD} + 0.4	V
DC Input Current	I _{IN}	± 5	mA
Input Diode Current	I _{ID}	± 5	mA
Output Diode Current	I _{OK}	5	mA
Power Dissipation	P	1.47	W
	F	0.96 (Note 1)	
	FW	1.00 (Note 2)	
Operating Temperature	T _{opr}	- 40~85	°C
Storage Temperature	T _{stg}	- 55~150	°C

(Note 1) On Glass Epoxy PCB (50×50×1.6mm Cu 40%)

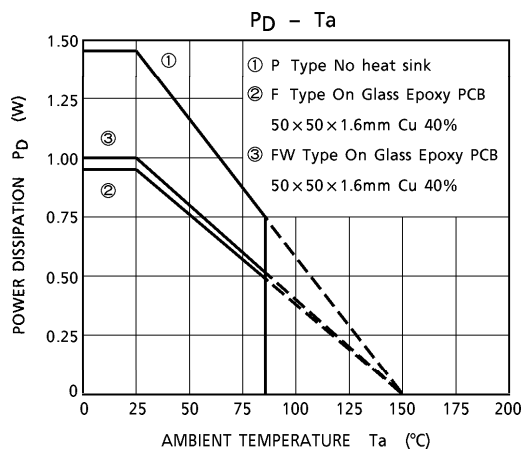
(Note 2) Delated above 25°C in the proportion of 7.7mW/°C (F Type), 8.0mW/°C (FW Type).

RECOMMENDED OPERATING CONDITION (Ta = - 40~85°C)

CHARACTERISTIC	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT		
Supply Voltage Range	V _{DD}	—	4.5	—	5.5	V		
DC Output Voltage	V _{DS}	—	—	—	30	V		
DC Output Current	I _{DS}	Duty 80%	8ch On V _{DD} = 5.0V	—	—	mA / ch		
							Duty 100%	
								P
		F						90
		FW					140	
		P					150	
F	80							
FW	120							
DC Input Voltage	V _{IN}	—	GND	—	V _{DD}	V		

ELECTRICAL CHARACTERISTICS (Ta = 25°C, VDD = 5.0V)

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Output Leakage Current	IOZ	—	VDS = 35V	—	—	50	μA
Low-Level Output Voltage	VDS	—	IDS = 150mA	—	0.70	0.8	V
		—	IDS = 200mA	—	0.94	1.2	
Output Resistance	RON	—	IDS = 200mA	—	4.7	6.0	Ω
DC Input Current	IIN	—	VIN = GND, VIN = VDD	—	—	± 1.0	μA
High-Level Input Voltage	VIN (H)	—	—	3.5	—	VDD + 0.4	V
	VIN (L)	—	—	-0.4	—	1.5	
Operating Supply Current	IDDopr	—	8ch On, Output open fIN = 1MHz	—	2	—	μA
Output Diode Forward Voltage	VFK	—	IOK = 5mA	—	0.6	—	V
Turn-On Delay	tON	—	IOUT = 170mA	—	300	—	ns
Turn-Off Delay	tOFF	—	—	—	300	—	
Supply Current	IDD	—	—	—	—	10	μA
Input Capacitance	CIN	—	—	—	15	—	pF

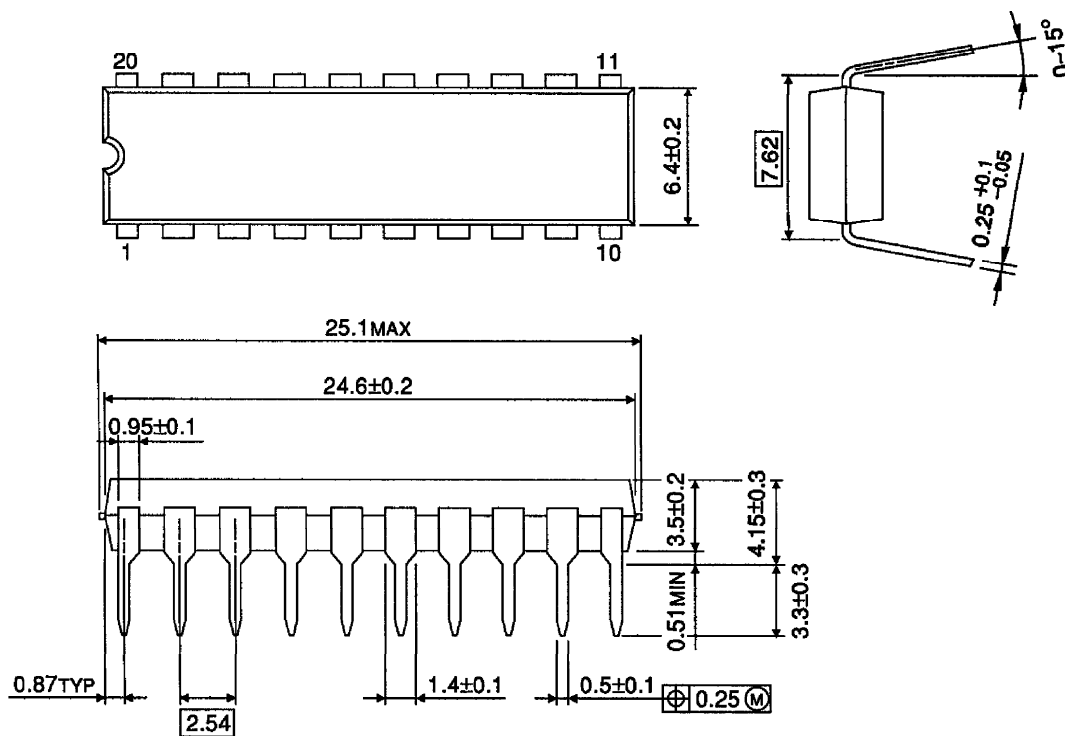


PRECAUTIONS for USING

Utmost care is necessary in the design of the output line, VCC (VDD) and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

OUTLINE DRAWING
DIP20-P-300-2.54A

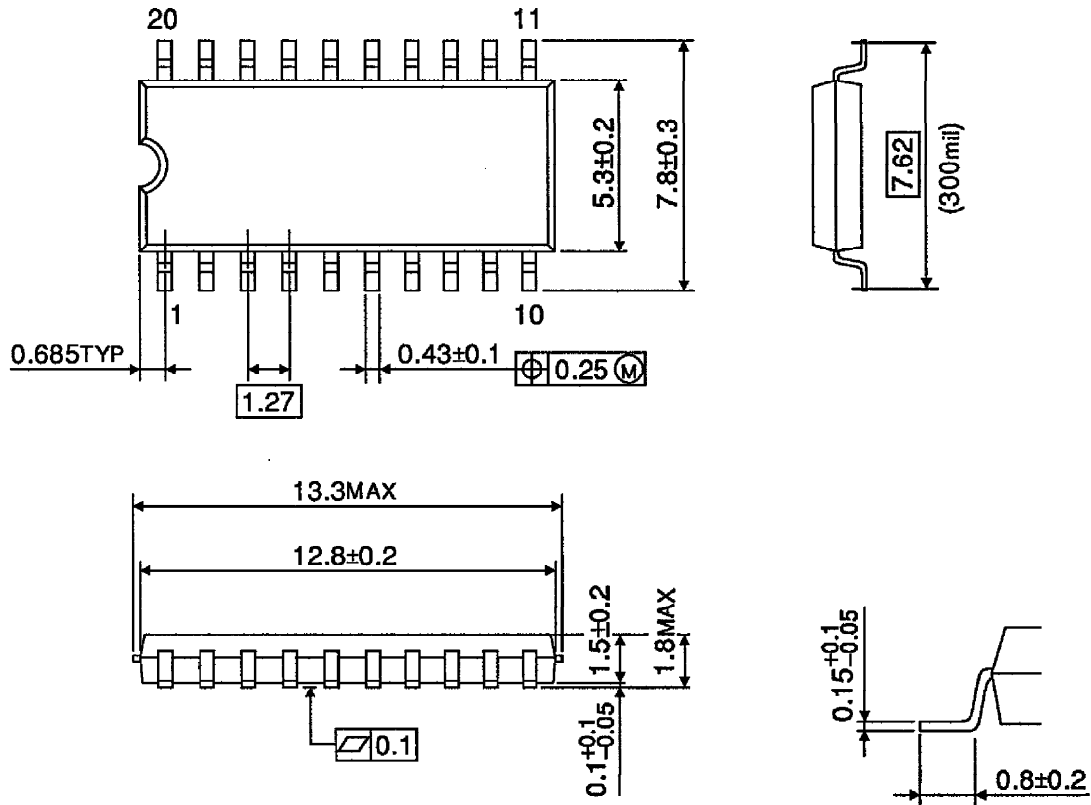
Unit : mm



Weight : 2.25g (Typ.)

OUTLINE DRAWING
SOP20-P-300-1.27

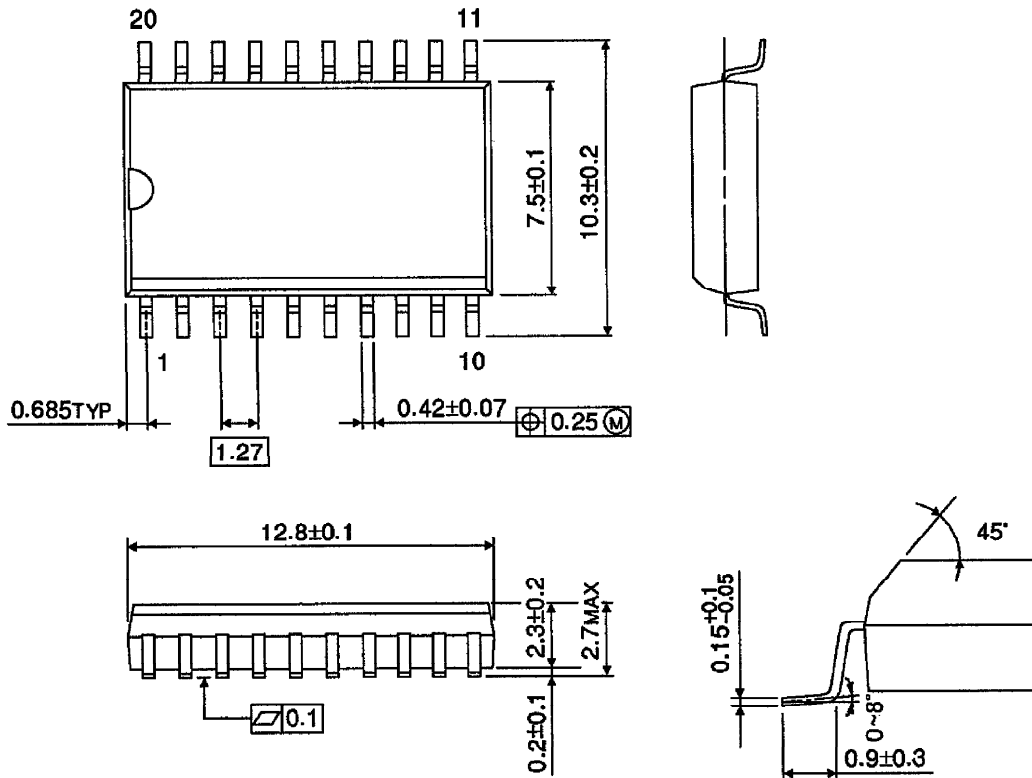
Unit : mm



Weight : 0.25g (Typ.)

OUTLINE DRAWING
SOL20-P-300-1.27

Unit : mm



Weight : 0.48g (Typ.)